

#### 74LCX540

# Low Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs

#### **General Description**

The LCX540 is an octal buffer/line driver designed to be employed as a memory and address driver, clock driver and bus oriented transmitter/receiver.

This device is similar in function to the LCX240 while providing flow-through architecture (inputs on opposite side from outputs). This pinout arrangement makes this device especially useful as an output port for microprocessors, allowing ease of layout and greater PC board density.

The LCX540 is designed for low voltage (3.3V)  $V_{CC}$  applications with capability of interfacing to a 5V signal environment. The LCX540 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

#### **Features**

- 5V tolerant inputs and outputs
- 6.5 ns t<sub>PD</sub> max, 10 µA l<sub>CCQ</sub> max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal
- 2.0V-3.6V V<sub>CC</sub> supply operation
- ±24 mA output drive
- Implements patented noise/EMI reduction circuitry
- Functionally compatible with 74 series 540
- Latch-up performance exceeds 500 mA
- ESD performance:

Human body model > 2000V Machine model > 200V

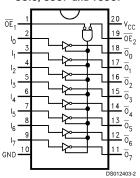
### **Ordering Code:**

Order Number	Package Number	Package Description			
74LCX540WM	M20B	20-Lead (0.300" Wide) Small Outline Integrated Circuit, SOIC, JEDEC			
74LCX540SJ	M20D	20-Lead Small Outline Package, SOIC, EIAJ			
74LCX540MSA	MSA20	20-Lead Molded Shrink Small Outline Package, SSOP, Type II			
74LCX540MTC	MTC20	20-Lead Thin Shrink Small Outline Package, TSSOP, JEDEC			

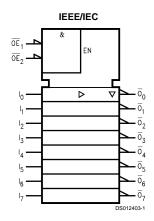
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### **Connection Diagram**

# Pin Assignment for SOIC, SSOP and TSSOP



# Logic Symbol



## **Truth Table**

Inputs			Outputs
ŌE <sub>1</sub>	ŌE 2	ı	
L	L	Н	L
Н	Χ	Χ	Z
X	Н	X	Z
L	L	L	Н

H = HIGH Voltage Level
X = Immaterial
L = LOW Voltage Level
Z = High Impedance

## Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Value	Conditions	Units
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0		V
VI	DC Input Voltage	-0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to V <sub>CC</sub> + 0.5	Output in High or Low State (Note 2)	V
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
I <sub>OK</sub>	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
		+50	V <sub>O</sub> > V <sub>CC</sub>	
Io	DC Output Source/Sink Current	±50		mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100		mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

## **Recommended Operating Conditions** (Note 3)

Symbol	Parameter	Min	Max	Units	
V <sub>CC</sub>	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	
VI	Input Voltage		0	5.5	V
Vo	Output Voltage	HIGH or LOW State	0	V <sub>CC</sub>	V
		3-STATE	0	5.5	
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	$V_{CC} = 3.0V - 3.6V$ $V_{CC} = 2.7V$		±24	mA
		$V_{CC} = 2.7V$		±12	
T <sub>A</sub>	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V		0	10	ns/V

Note 1: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: I<sub>O</sub> Absolute Maximum Rating must be observed.

Note 3: Unused (inputs or I/O's) must be held HIGH or LOW. They may not float.

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = -40°0	C to +85°C	Units
			(V)	Min	Max	
V <sub>IH</sub>	HIGH Level Input Voltage		2.7-3.6	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage		2.7-3.6		0.8	V
V <sub>OH</sub>	HIGH Level Output Voltage	I <sub>OH</sub> = -100 μA	2.7-3.6	V <sub>CC</sub> - 0.2		V
		I <sub>OH</sub> = -12 mA	2.7	2.2		V
		I <sub>OH</sub> = -18 mA	3.0	2.4		V
		I <sub>OH</sub> = -24 mA	3.0	2.2		V
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	2.7-3.6		0.2	V
		I <sub>OL</sub> = 12 mA	2.7		0.4	V
		I <sub>OL</sub> = 16 mA	3.0		0.4	V
		I <sub>OL</sub> = 24 mA	3.0		0.55	V
l <sub>l</sub>	Input Leakage Current	0 ≤ V <sub>I</sub> ≤ 5.5V	2.7-3.6		±5.0	μA
l <sub>oz</sub>	3-STATE Output Leakage	0 ≤ V <sub>O</sub> ≤ 5.5V	2.7-3.6		±5.0	μA
		$V_I = V_{IH}$ or $V_{IL}$				
I <sub>OFF</sub>	Power-Off Leakage Current	V <sub>I</sub> or V <sub>O</sub> = 5.5V	0		10	μA
Icc	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	2.7-3.6		10	μA
		$3.6V \le V_{I}, V_{O} \le 5.5V$	2.7-3.6		±10	μA
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> -0.6V	2.7-3.6		500	μA

# **AC Electrical Characteristics**

Symbol	Parameter	$T_A = -40^{\circ}C$ to +85°C, $C_L = 50$ pF, $R_L = 500\Omega$			Units		
		V <sub>CC</sub> = 3.	3V ±0.3V	±0.3V V <sub>CC</sub> = 2.7V			
		Min	Max	Min	Max	1	
t <sub>PHL</sub>	Propagation Delay	1.5	6.5	1.5	7.5	ns	
t <sub>PLH</sub>		1.5	6.5	1.5	7.5		
t <sub>PZL</sub>	Output Enable Time	1.5	8.5	1.5	9.5	ns	
$t_{PZH}$		1.5	8.5	1.5	9.5		
t <sub>PLZ</sub>	Output Disable Time	1.5	7.5	1.5	8.5	ns	
t <sub>PHZ</sub>		1.5	7.5	1.5	8.5		
t <sub>OSHL</sub>	Output to Output Skew (Note 4)		1.0			ns	
t <sub>OSLH</sub>			1.0				

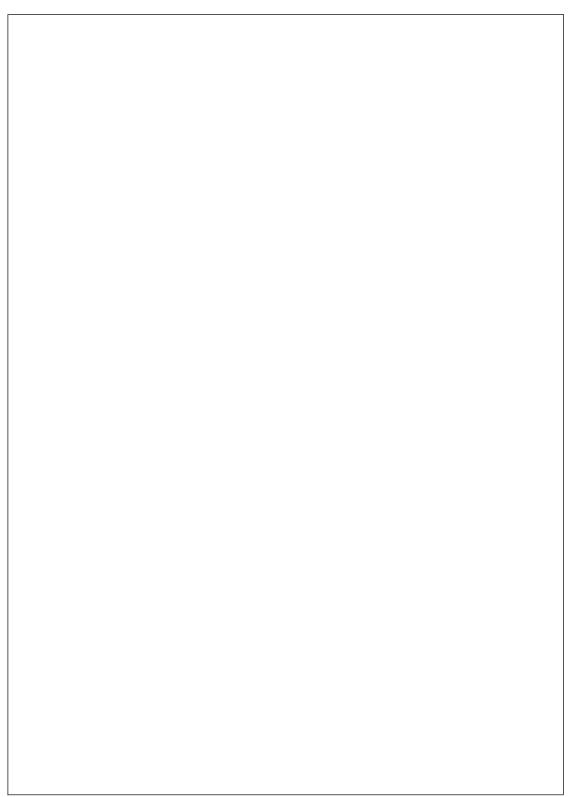
Note 4: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH to LOW  $(t_{OSHL})$  or LOW to HIGH  $(t_{OSLH})$ .

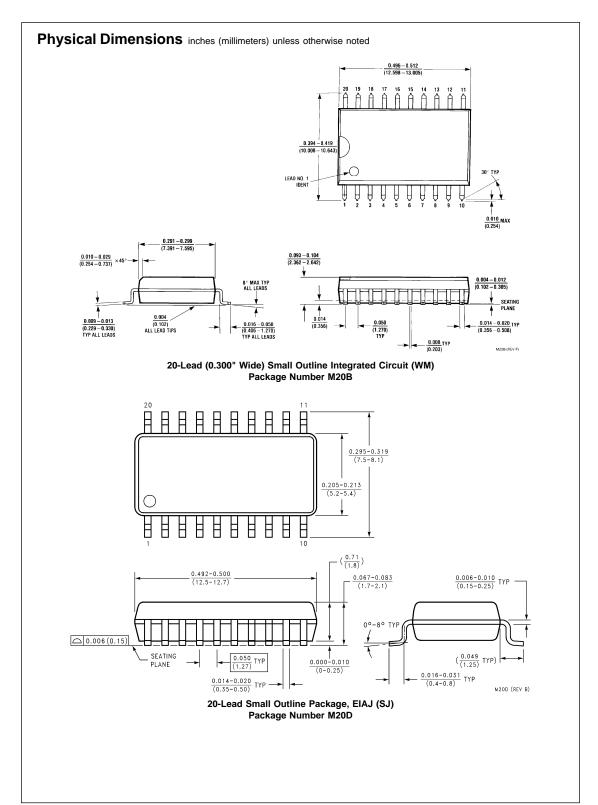
## **Dynamic Switching Characteristics**

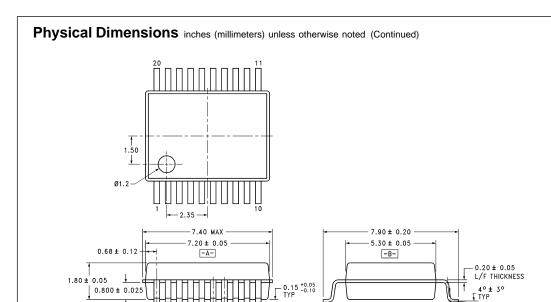
Symbol	Parameter	Conditions	V <sub>cc</sub>	T <sub>A</sub> = 25°C	Units
			(V)	Typical	
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	C <sub>L</sub> = 50 pF, V <sub>IH</sub> = 3.3V, V <sub>IL</sub> = 0V	3.3	0.8	V
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V

## Capacitance

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = Open, V <sub>I</sub> = 0V or V <sub>CC</sub>	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 3.3V, $V_{I}$ = 0V or V $_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC} = 3.3V, V_{\perp} = 0V \text{ or } V_{CC}, f = 10 \text{ MHz}$	25	pF







20-Lead Molded Shrink Small Outline Package, EIAJ, Type II Package Number MSA20

0.30 ± 0.10 TYP

♦ 0.12 M C AS BS

- 0.60 ± 0.15 TYP MSA20 (REV A)

#### Physical Dimensions inches (millimeters) unless otherwise noted (Continued) DIMENSIONS METRIC ONLY 7.72 4.16 (1.78 TYP) $6.5 \pm 0.1$ - A -0.42 TYP 0.65 TYP LAND PATTERN RECOMMENDATION GAGE PLANE 6.4 4.4 ± 0.1 -B-3.2 SEATING PLANE 0.6 ± 0.1 DETAIL A △ 0.2 C B A TYPICAL SEE DETAIL D ALL LEAD TIPS (0.90)□ 0.1 C ALL LEAD TIPS -C-0.65 TYP 0.09-0.20 0.10 ± 0.05 TYP 0.19 - 0.30 TYP 0.13 M Α B (S) c (S) MTC20 (REV C) 20-Lead Thin Shrink Small Outline Package, JEDEC Package Number MTC20

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National Semiconductor

Tel: 81-3-5620-6175

Japan Ltd.

Fairchild Semiconductor Corporation Americas Tel: 1-888-522-5372

Fairchild Semiconductor Europe

Fax: +49 (0) 1 80-530 85 86 Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 8 141-35-0
English Tel: +44 (0) 1 793-85-68-56
Italy Tel: +39 (0) 2 57 5631

Fairchild Semiconductor Hong Kong Ltd. 13th Floor, Straight Block, Ocean Centre, 5 Canton Rd. Tsimshatsui, Kowloon

Fax: 81-3-5620-6179 Hong Kong Tel: +852 2737-7200 Fax: +852 2314-0061

www.fairchildsemi.com